

Appl. No. : 10/618,957
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AMENDMENT TO THE ABSTRACT

Please amend the Abstract as follows:

To provide a surface protective film for transparent conductive substrates having sufficient transparency and heat resistance, and not demonstrating white turbiness, even when it is placed under a heated environment in a state where the surface protective film is attached on the transparent conductive substrate. A surface protective film for transparent conductive substrates protecting a surface on a side opposite to a conductive thin film or a surface on a side of the conductive thin film of the transparent conductive substrate, wherein an adhesive layer is formed on one side of a base material film, and an antistatic layer is formed on the other side.

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